

RELIABILITY REPORT FOR

DS3930, Rev A1

Dallas Semiconductor

4401 South Beltwood Parkway Dallas, TX 75244-3292

Prepared by:

Ken Wendel

Ken Wendel Reliability Engineering Manager Dallas Semiconductor 4401 South Beltwood Pkwy. Dallas, TX 75244-3292

Email: ken.wendel@dalsemi.com

ph: 972-371-3726 fax: 972-371-6016 mbl: 214-435-6610

Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products and processes:

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport/dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

```
AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts
AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10-5 eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
Ea = Activation Energy (e.g. 0.7 ev)
```

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

```
AfV = exp(B*(Vs - Vu))

AfV = Acceleration factor due to Voltage

Vs = Stress Voltage (e.g. 7.0 volts)

Vu = Maximum Operating Voltage (e.g. 5.5 volts)

B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)
```

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

```
Fr = X/(ts * AfV * AfT * N * 2)
X = Chi-Sq statistical upper limit
N = Life test sample size
```

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 24911 FITS: 4.6

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 5.5 Volts

The reliability data follows. A the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available.

Device Information:

DESCRIPTION

STORAGE LIFE

STORAGE LIFE

Process: D6W-2P2M,HPVt,E2,EPROGVt,TCZ ALOCOS:GOI

Passivation: Passivation w/Nov TEOS Oxide-Nitride

Die Size: 135 x 115 Number of Transistors: 8000

Interconnect: Aluminum / 1% Silicon / 0.5% Copper

DATE CODE CONDITION

150C

150C

0305

0320

Gate Oxide Thickness: 150 Å

ELECTRICAL CHARACTERIZATION													
DESCRIPTION	DATE COD	E CONDITION	REA	DPOINT	QUANTITY	FAILS							
ESD SENSITIVITY	0315	EOS/ESD S5.1 HBM 500 VOLTS	1	PUL'S	3	0							
ESD SENSITIVITY	0315	EOS/ESD S5.1 HBM 1000 VOLTS	1	PUL'S	3	0							
ESD SENSITIVITY	0315	EOS/ESD S5.1 HBM 2000 VOLTS	1	PUL'S	3	0							
ESD SENSITIVITY	0315	EOS/ESD S5.1 HBM 4000 VOLTS	1	PUL'S	3	3							
ESD SENSITIVITY	0315	EOS/ESD S5.1 HBM 8000 VOLTS	1	PUL'S	3	3							
LATCH-UP	0315	JESD78, I-TEST 125C			6	0							
LATCH-UP	0315	JESD78, Vsupply TEST 125C			6	0							
				Total:									
OPERATING LIFE													
DESCRIPTION	DATE COD	E CONDITION	REA	DPOINT	QUANTITY	FAILS							
HIGH VOLTAGE LIFE	0251	125C, 6.0 VOLTS	1000	HRS	45	0							
HIGH VOLTAGE LIFE	0305	125C, 6.0 VOLTS	1000	HRS	45	0							
HIGH TEMP OP LIFE	0314	125C, 5.5 VOLTS	1000	HRS	77	0							
HIGH TEMP OP LIFE	0315	125C, 5.5 VOLTS	1000	HRS	45	0							
				То	tal:	0							
STORAGE LIFE													

READPOINT QUANTITY FAILS

77

77

0

0

1000 HRS

192 HRS

W/E ENDURANCE AND DATA RET'N											
DESCRIPTION	DATE CODE CONDITION		READPOINT		QUANTITY	FAILS					
WRITE CYCLE STRESS	0251	70 C, 6.0 VOLTS		30	KCYS	77	0				
STORAGE LIFE		150C		1000	HRS	77	0				
WRITE CYCLE STRESS	0314	70 C, 5.5 VOLTS		30	KCYS	77	0				
STORAGE LIFE		150C		96	HRS	77	0				
WRITE CYCLE STRESS	0315	70 C, 5.5 VOLTS		30	KCYS	77	0				
STORAGE LIFE		150C		96	HRS	77	0				
WRITE CYCLE STRESS	0325	85 C, 5.5 VOLTS		30	KCYS	77	0				
WRITE CYCLE STRESS	0327	70 C, 5.5 VOLTS		30	KCYS	77	0				
					Tot	al:	0				

FAILURE RATE: MTTF (YRS): 24911 FITS: 4.6